TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC191AP, TC74HC191AF

4-Bit Binary Up/Down Counter

The TC74HC191A are high speed CMOS 4-BIT UP/DOWN COUNTERs fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent

LSTTL while maintaining the CMOS low power dissipation.

The TC74HC191A is 4-bit binary up/down counter.

They have an asynchronous load input ($\overline{\mathrm{LOAD}}$) which is active low.

The direction of counting is determined by the level of DOWN/UP. When D/U is low, the counter counts up; when D/U is high, it counts down. Counting occurs on the positive going transition of the clock input.

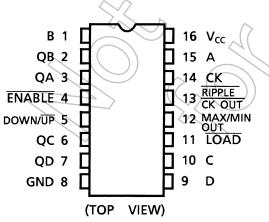
 $\begin{array}{l} \mbox{Enable input (\overline{ENABLE}) and two carry inputs (RIPPLE CLOCK OUT, MAX/MIN) are provided to permit easy cascading of the counters, which facilitates easy implementation of N-bit counters without using external gates. \end{array}$

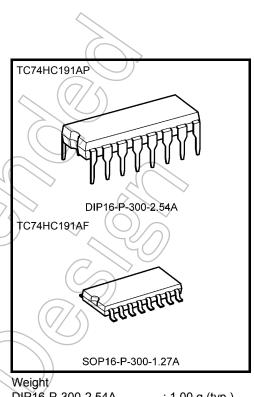
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: fmax = 48 MHz (typ.) at $V_{CC} = 5 V$
- Low power dissipation: $I_{CC} = 4 \mu A \pmod{at}$ at $Ta = 25^{\circ}C$
- High noise immunity: $V_{\text{NIH}} = V_{\text{NIL}} \neq 28\% V_{\text{CC}}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH | = IOL = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 6 V
- Pin and function compatible with 74LS191

Pin Assignment





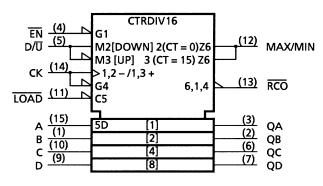
DIP16-P-300-2.54A SOP16-P-300-1.27A

: 1.00 g (typ.) : 0.18 g (typ.)

Start of commercial production 1988-11

<u>TOSHIBA</u>

IEC Logic Symbol



Truth Table

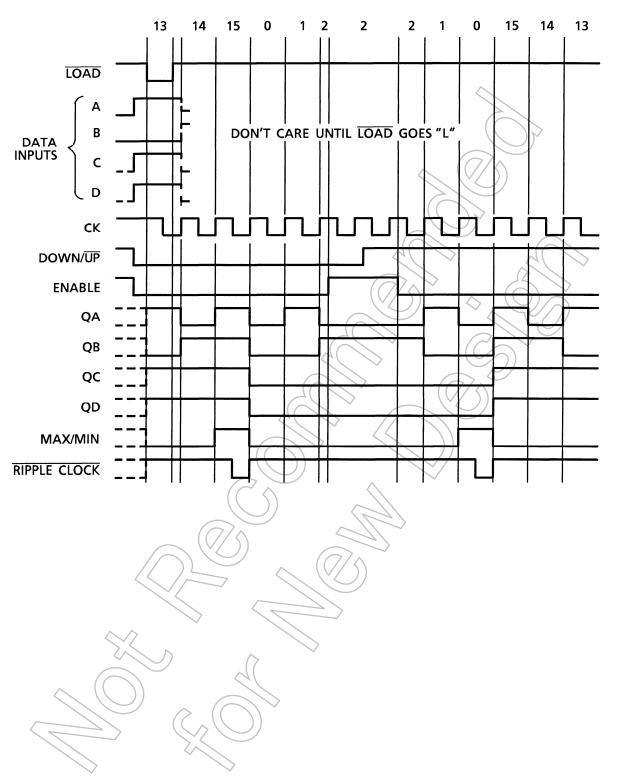
	Inputs				Out	Outputs Funct			
LOAD	ENABLE	D/Ū	СК	QA	QB	QC	QD	T UNQUON	
L	Х	Х	Х	а	b c d		Preset Data		
Н	L	L			Up C	Up Count			
Н	L	Н			Down	Down Count			
н	н	Х		No Change			No Count		
Н	Х	Х			No Cl	No Count			

X: Don't care

a to d: Inputs level of A to D

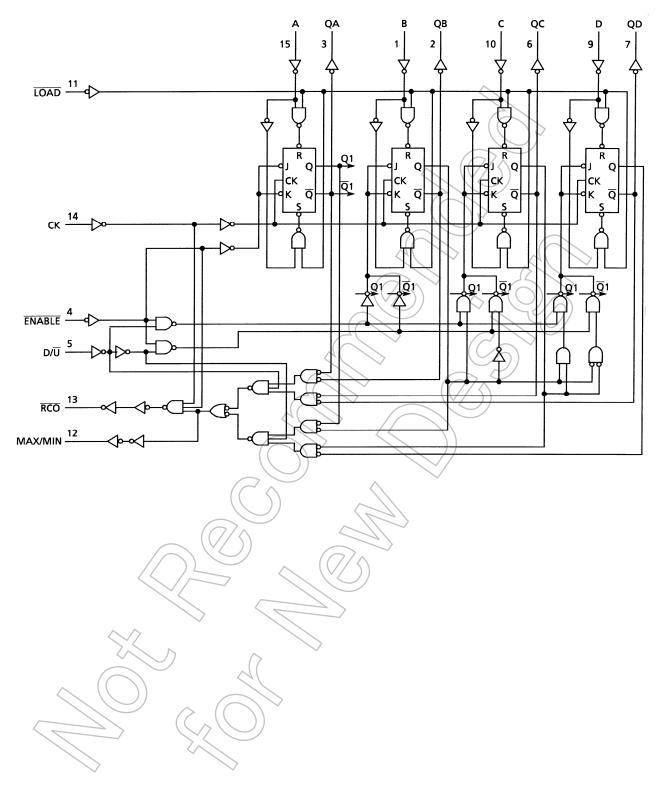
TOSHIBA

Timing Chart



TOSHIBA

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	–0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	Iк	±20	mA
Output diode current	I _{ОК}	±20	(mA)
DC output current	IOUT	±25	mA
DC V _{CC} /ground current	ICC	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	VOUT	0 to V _{CC}	V
Operating temperature	Topr	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Operating Ranges (Note)

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol Test Condition			٦	Га = 25°С)	Ta = -40 to 85°C		Unit	
				$V_{CC}(V)$	Min	Тур.	Max	Min	Max	
				2.0	1.50	_	À	1.50	_	
High-level input voltage	VIH			4.5	3.15	—	(=)	3.15	—	V
J. J				6.0	4.20	-	\mathcal{A}	4.20	_	
				2.0	>	-67	0.50	_	0.50	
Low-level input voltage	VIL	—		4.5	_		1.35	—	1.35	V
J. J				6.0	-((1.80	_	1.80	
	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	1.9		
				4.5	4.4	4.5	—	4.4		
High-level output voltage				6.0	5.9	6.0	_	5.9	\geq	V
_			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	-6	4.13	$\geq -$	
			I _{OH} = -5.2 mA	6.0	5.68	5.80		5.63) —	
				2.0	_	0.0	0.1	Z	0.1	
			$I_{OL} = 20 \ \mu A$	4.5	—	0.0	0.1	~_	0.1	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}		6.0	_	0.0	0.1		0.1	V
_			$I_{OL} = 4 \text{ mA}$	4.5	—	0.17 <	0.26	—	0.33	
			I _{OL} = 5.2 mA	6.0		0.18	0.26		0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_)-	±0.1	_	±1.0	μA
Quiescent supply current	ICC	VIN = V _{CC} or	GND	6.0		/_	4.0	_	40.0	μΑ

2014-03-01

Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = _40 to 85°C	Unit	
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width	the cur		2.0		100	125	
(CK)	tw (H)	—	4.5 <	\geq	20	25	ns
	^t W (L)		6.0	\geq	17	21	
Minimum pulse width			2.0	(\in)	75	95	
(LOAD)	t _{W (L)}	—	4.5		15	19	ns
			6.0	$\langle \rangle$	13	16	
Minimum set-up time			2.0		150	190	
$(\overline{ENABLE}, D/\overline{U})$	ts		(4.5)	>	30	38	ns
		6	6.0	_	26	33	
Minimum set-up time		21	2,0	—	50	65	
(DATA-LOAD)	ts		4.5	- (2 10	13	ns
(6.0	-(())9	11	
Minimum hold time			2.0	$\langle \langle \rangle$	Y)	0	
$(\overline{ENABLE}, D/\overline{U})$	t _h		4.5	7	$>$ \sim	0	ns
		$\langle \langle \rangle \rangle$	6.0	2)	0	0	
Minimum hold time			2.0		0	0	
(DATA-LOAD)	t _h	$\langle \langle \rangle \rangle$	4.5) —	0	0	ns
			6.0	_	0	0	
			2.0	—	50	65	
Minimum removal time	t _{rem})) - //	4.5	—	10	13	ns
	\square		6.0	—	9	11	
			2.0	—	5	4	
Clock frequency	f		4.5	—	25	20	MHz
	$(\sqrt{5})$		6.0		29	24	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	tтLH	_	_	4	8	ns
	t _{THL}			-	•	
Propagation delay time	t _{pLH}			18	31	ns
(CK-Q)	t _{pHL}		\geq	10	51	115
Propagation delay time	t _{pLH}	_	(20	ns
(CK-RCO)	t _{pHL}				20	115
Propagation delay time	t _{pLH}		\times	23	42	ns
(CK-MAX/MIN)	t _{pHL}		T	25	72	115
Propagation delay time	t _{pLH}		>	21	35	ns
(LOAD -Q)	t _{pHL}			21	55	115
Propagation delay time	t _{pLH}	$\mathcal{A}(\mathbb{N})$		~17	30	ns
(DATA-Q)	t _{pHL}				50	115
Propagation delay time	t _{pLH}	$(\mathbb{Z}/5)^{\sim}$			17	ns
(ENABLE - RCO)	t _{pHL}) ''	115
Propagation delay time	t _{pLH}			17	31	ns
(D/ U - RCO)	t _{pHL}			<i>▼</i> 1 <i>1</i>	51	113
Propagation delay time	t _{pLH}		\mathbb{Z}	15	27	ns
(D/ U -MAX/MIN)	t _{pHL}			15	21	115
Maximum clock frequency	f _{max}		27	48		MHz

AC Characteristics ($C_L = 50 \text{ pF}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		٦	「a = 25°0	C	Ta –40 to		Unit
	-		V _{CC} (V)	Min	Тур.	Max	Min	Max	
			2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8 <	15		19	ns
	t _{THL}		6.0	—	7	13	_	16	
Propagation delay	4		2.0	_	88	180		225	
time	t _{pLH}	—	4.5	_	22	36	2_	45	ns
(CK-Q)	t _{pHL}		6.0	\prec	19	31	_	38	
Propagation delay	+		2.0	->	52	120		150	
time	t _{pLH}	—	4.5	_((13	24	—	30	ns
(CK-RCO)	tpHL		6.0)J	20		26	
Propagation delay	t _{pLH}		2.0 🗸		108	240	Å	300	
time	t _{pHL}	—	4.5	\rightarrow	27	48	$\langle + \rangle$	60	ns
(CK-MAX/MIN)	-pric		6.0	()	23	41	D + c	51	
Propagation delay	t _{pLH}	(2.0	2	100	205	4)	255	
time (LOAD -Q)	t _{pHL}	- 6	4.5	_	25	41	\geq	51	ns
(LOAD -Q)	p=	40	6.0		22	35		43	
Propagation delay time	t _{pLH}		2.0	—	84	(175		220	
(DATA-Q)	t _{pHL}		4.5 6.0		21	35 30	_	44 37	ns
· · ·			2.0		56	105		130	
Propagation delay time	t _{pLH}		2.0 4.5		14	21		26	ns
(ENABLE - RCO)	t _{pHL}		6.0	\geq	12	18		22	110
Propagation delay			2.0	_	84	180	_	225	
time	t _{pLH}		4.5	<u> </u>	21	36	_	45	ns
(D/ U - RCO)	tpHL	7/5	6.0	_	18	31	_	38	
Propagation delay			2.0	_	72	160	_	200	
time	t _{pLH}		4.5	—	18	32	—	40	ns
(D/ U -MAX/MIN)	tрңĽ		6.0	_	15	27	—	34	
	\sim		2.0	5	11		4	_	
Maximum clock frequency	f _{max}	->>	4.5	25	44	—	20	—	MHz
	\sim		6.0	29	52	—	24	—	
Input capacitance	CIN			—	5	10	—	10	pF
Power dissipation capacitance	C _{PD} (Note)	—		—	101	—	—	—	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

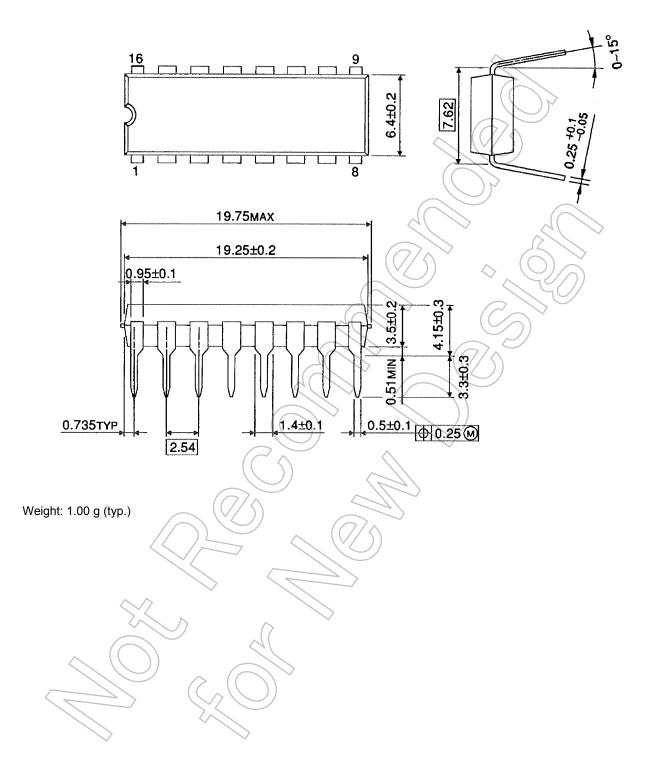
Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Package Dimensions

DIP16-P-300-2.54A

Unit : mm

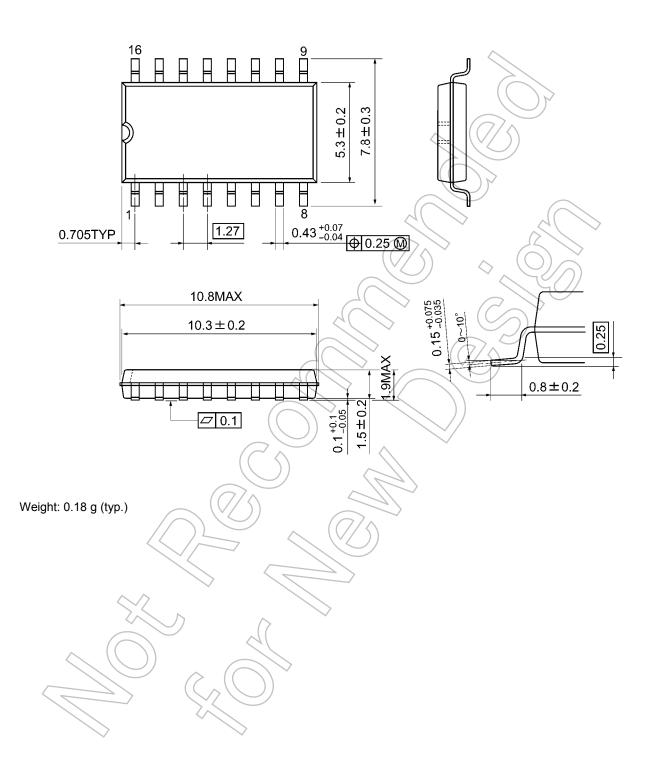




Package Dimensions

SOP16-P-300-1.27A

Unit: mm



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